Design Failure Modes and Effects Analysis

DFMEA with Suppliers

Copyright © 2003-2007 Raytheon Company. All rights reserved. R6 σ is a Raytheon trademark registered in the United States and Europe. Raytheon Six Sigma is a trademark of Raytheon Company. R6s is a trademark of Raytheon Company.



Design Failure Modes and Effects Analysis

- A structured approach that ensures potential product failure modes and their associated causes have been considered and addressed in the product design
 - What can go wrong?
 - Where will the variation come from?
 - How can we prevent or control?



Design and sell products so that in the future the customer returns, **NOT** the product

- Performing DFMEAs on existing or new product designs allows:
 - Early identification of the ways the product design can fail
 - Rational prioritization of potential failures so that corrective/preventive action and/or redesign can be accomplished before risk and cost can escalate
 - Smoother production ramps
 - Enhanced system reliability once countermeasures are implemented
 - Reduced development, production and warranty cost
 - Higher customer and end-user satisfaction



Overview of the DFMEA Process

- People knowledgeable about the product analyze situations where critical customer requirements might not be met
- A ranking system is used to estimate three factors:
 - how **Severe** the failure would be
 - how frequently the failure would **Occur**,
 - how difficult it would be to <u>Detect</u>, and
- These three factors are multiplied and the resulting value is called the Risk Priority Number (RPN).
- The RPN is used to prioritize the failure modes so that corrective actions can be taken to reduce the frequency, and severity and/or improve the detectability of the failure mode.



DFMEA Benefits

- Part of an objective evaluation of design requirements and alternatives
- Helps to identify potential Critical Characteristics and Significant Characteristics
- Identifies potential failure modes ranked according to their effect on the customer; establishes a priority system for design improvement and development testing while still in the design phase
- Provides critical input for the planning of effective design test and development programs
- Provides an open issue format for recommending and tracking riskreduction actions
- Aids in analyzing field concerns, evaluating design changes and developing advanced designs



Supplier DFMEA Benefits

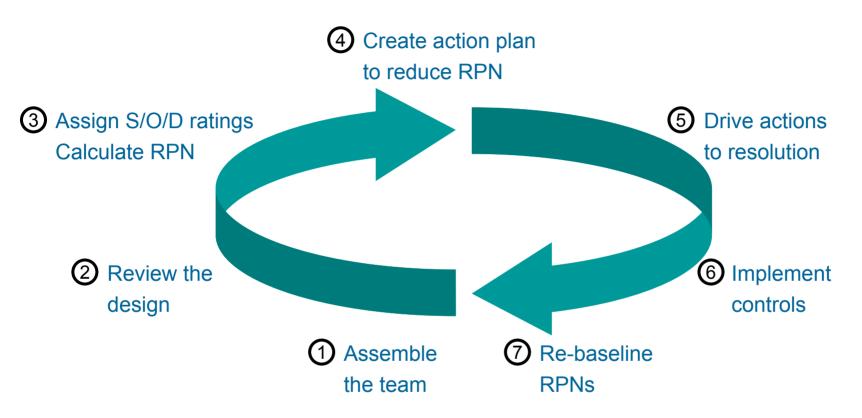
- Proactive and collaborative; become more than "just a vendor"
- Identify issues which might drive in-process or post-process failures
- Suggest risk-mitigation alternatives for design incorporation
 - Features
 - Dimensions
 - Materials
 - Finishes
 - Validation requirements
- Opportunity to influence through added-value during the design phase
- Expected as part of quote package



- Select proper team and organize members
- Select teams for each product or system
- Create/agree on a ranking system
- Agree on format for DFMEA matrix
- Define the customer and customer needs/expectations
- Design requirements



DFMEA Flow



FAILURE MODE: How a product can fail to meet design specifications or functional intent
 CAUSE: A deficiency that results in a failure mode → e.g. sources of variation
 EFFECT: Impact on customer if the failure mode is not prevented or corrected



Typical DFMEA Team Members

- Design Engineer Generally the Team Leader
- Project Manager
- Manufacturing/Assembly Engineer
- Process Engineer
- Quality Engineer
- Test Engineer
- Reliability Engineer
- Materials Engineer
- Field Service Engineer
- Component Process Engineer
- Others, as required, including Sales, Marketing, QA/QC, Packaging



Customer Success Is Our Mission

Reviewing the Design

- Construct a block diagram that fully describes coupling and interfaces at all levels; interfaces include controlled inputs (e.g. design parameters) and uncontrolled inputs (noise factors)
- All design parameter inputs should be associated with a corresponding component or subsystem providing the input
- Functional requirements (FR's, or outputs) at each block level are defined
- For each FR, the team brainstorms all potential failure modes that would prevent the design from failing to satisfy each FR
- For each failure mode, the team brainstorms causes and effects
 - Design weakness because of axiom violation (meets specs but fails to perform)
 - Manufacturing and/or assembly vulnerability or deficiency
 - Process variation
 - Usage
 - Environmental factors
 - Mistakes/errors
 - Deterioration
- Information is used as the input to the DFMEA template



Organizing Information Using the DFMEA Template

Raytheon Customer Success Is Our Mission

- List each design requirement of concern in each topic area
 - Tolerancing/Materials/Finishes/Test specs/Others
- Describe the potential failure modes for each feature/requirement
- Identify the impact of each potential failure mode on downstream processes, product functionality, system performance or the customer experience
- Identify likely causes in the design or process for these failure modes
- Describe the current design controls—if they exist—that are in place to contain the failure mode causes
- Assign appropriate values to <u>Severity</u>/<u>O</u>ccurrence/<u>D</u>etectability to obtain RPN (note: scale descriptions are included in DFMEA template)
 - **Severity:** Scale 1-10, 1=no impact, 10=catastrophic impact/hazardous
 - <u>O</u>ccurrence: Scale 1-10, 1=predicted <3 defects/million, 10=>500K defects/million
 - <u>D</u>etectability: Scale 1-10, 1=always detected by current control plan, 10=unable to detect
- Sort design requirements of concern by RPN number high-to-low to prioritize the action plan for maximum impact



DFMEA Template



FMEA Objective, scope	and goal(s):												1		
													D	-	8
													R	6C	5
													Rayther	an Six Sig	ma
Drawing/Spec Number:						Т		FMEA Type:							
System:								FMEA Number:							
Subsystem:								Prepared By:							
Component:	¢							FMEA Date:							
Design Lead:								Revision Date:							
Raytheon Core Team	6														- 1
Members:															
Supplier Core Team Members:	5														
													_		_
					1						Action Res				
Functional Requirement /	State of the state	Potential Effect(s)	>	Potential Cause(s)/ Mechanism(s)	na mana a an an a 🗜		z	Recommended		Completion		>	New OCC	E 7	z
Design Parameter	Potential Failure Mode(s)	of Failure	SEV	Potential Cause(s)/ Mechanism(s) of Failure	Current Design/Process Controls	51	RP	Action(s)	Owner	Date	Actions Taken	SE	ŏ	a i	Кŧ
2 condition		of Failard		-				, lotter l(c)		2 dite	Activity Tuken	ew	ew	ew	ew
												z	Z	z	۴
			0	0	0	0	0								0
	о С		0	0			0								0
			0		0	0	0								0
			0	0			0								0
1		5	0	0			0	0		2		_			0
			0	0			0					_	4		0
-			0	0	L L	U	0			-		_			0
	2	3	0	0			0			-			-	-	0
-	<u>.</u>		0	0			0								0
		7	0	0	1	0	0	3		-					0
		ð	0	0	0	n l	0								0 0 0
	°	0	0	0			0								0
1	6	Q	0	0			0								0
7	×		0	0	0	0	0								0
			0	0		0	0			1					0
			0	0			0	2		1				10	0
			0	0			0			3	í.				0
	2		0	0		0	0								0
	2	5	0	0			0								0
			0	0	0	0	0								0
-			0	0			0								0
-			0	0			0					_			0
			0	0			0			-					0
A STATE OF	15.4		0	U		9	0				1				0
Areas to consider in the DFI	ALA					_							_		_
Dimensions/Tolerancing Material															
Finish															
Test specifications															
Other Issues															
Raytheon															
Customer Success Is Our Mission															



DFMEA Template



DFMEA Example



Drawing Spee Number: XXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXXX	er		_
Subsystem: Controller CCA Prepared By: Application Enginee Component: HV Capacitor FMEA Date: #18/2006 Design Lead: Supplier Application Engineer #18/2006 #18/2006 Raytheon Core Team Revision Date: 1/21/2/2006 Members: Design Engineer 1/21/2/2006	er		
Design Lead: Supplier Application Engineer Revision Date: 12/15/2008 Revision Core Team Members: Design Engineer			
Raytheon Core Team Members: Design Engineer			
Members: Design Engineer			
wernners s: Design Engineer Supplier Core Team Members: Application Engineer, Design Engineer, Trocess Engineer, Materials Engineer			
auphre core rean memores Approation Engineer, roose Engineer, roos Engineer, materiale Engineer			
	Action Re	sults	
Functional Requirement / Design Parameter Potential Failure Mode(s) Potential Effect(s) of Failure Design Parameter Potential Failure Mode(s) Potential Effect(s) of Failure Potential Cause(s)/ Mechanism(s) of Failure Potential Cause(s)/ Mecha	ompletion Date Actions Taken	New SEV	New OCC New DFT
Vielectric in package size - 4 lack of impreg corona, capacitance 8 thickness, tension, can dimension 8 none 10 640 Design Parameter DOE (1) DE/AE/TE mr film & 17 ga Al	Complete	8	2 2
bielectric in package size - 4 wrinkles hi-pot, corona, capacitance 8 tension, acceleration, speed, material 6 FAV, material cert, visual 8 384 Develop in-process spec DE/PE/ME/QE/ um film & 17 ga Al	Complete		1 2
erminal brazing pin holes, voids, dimensions leaks, dimensional tolerances 8 temperature, time, fidures, setup 8 He leak test 5 320 Process DOE (2) PEME/QE/Ops	Complete		2 2
Corona dielectric breakdown early failure 10 vaccum, contaminated fluid / film, sharp edges, foreign objects FOE FOE requirements PE/ME/QE	Complete		1 2
Dielectric in package size - 4 variation in length capacitance 8 tension, winding controls, thickness 6 FAV, capacitance test 3 144 Design Parameter DOE (1) DE/AE/PE	Complete		1 2
arass can welding pin holes, voids, dimensional tolerances 8 contamination, temp, skill 8 bubble test, He leak test 2 128 Operator certification PE/QE	Complete		1 2
Dielectric in package size - 4 stretching hi-pot, capacitance 8 tension, speed 4 FAV 3 96 Design Parameter DOE (1) DE/AE/PE	Complete		1 2
Dissipation factor overheat open, short 8 poor swage, contaminated oil 6 LCR meter 2 96 Review/revise material cleanliness PE/ME/QE requirements	Complete		1 2
Dielectric in package size - 4 variation in thickness capacitance 8 supplier capability 8 Incoming measurement 1 64 Design Parameter DOE (1) DE/AE/PE	Complete	8	1 1
Dielectric in package size - 4 over dimension doesn't fit 8 thickness, tension 8 pre / post cure dimension 1 64 Process DOE (1) DE/PE/ME/QE/ Um film & 17 ga Al	Complete	8	1 1



Design Failure Cause Examples

Raytheon Customer Success Is Our Mission

- Improper tolerancing
- Incorrect stress calculations
- Wrong assumptions
- Wrong material callout
- Lower grade component
- Lack of design standards
- Improper heat treatment
- Improper torque callout



AIAG Compiled Ratings						
Rating	Severity of effect	Likelihood of Occurrence	Ability to Detect			
10	Hazardous and without warning	Very high; failure is almost	Cannot detect			
9	Hazardous and with warning	inevitable	Very remote chance of detection			
8	Loss of primary function	Lligh: you a stad failuraa	Remote chance of detection			
7	Reduced primary function performance	High; repeated failures	Very low chance of detection			
6	Loss of secondary function		Low chance of detection			
5	Reduced secondary function performance	Moderate; occasional failures	Moderate chance of detection			
4	Minor defect noticed by most customers		Moderately high chance of detection			
3	Minor defect noticed by some customers	Low relatively few failures				
2	Minor defect noticed by discriminating customers	Low; relatively few failures				
1	No effect	Remote: failure is unlikely	Almost certain detection			
	Severity	Occurrence	Detectability			



Defining the Action Plan

- If the design control in place for the design characteristic are adequate, no further action is required (typically if RPN value is <20)
- If the design controls for the characteristic are inadequate:
 - Identify differences between the current and the desired situation
 - Determine how the failure can be better contained and/or eliminated
 - Consider implementation of new or more effective design controls
 - Determine if design modification is effective at eliminating or reducing occurrence or detectability of the failure mode, and if it can be accommodated
- Document plan and reassess S/O/D and RPN values; is it enough?
- Separate between
 - Supplier actions
 - Raytheon actions
 - Joint actions
- Publish result and include in quote/feedback to Raytheon Engineering and Procurement teams
- Manage to the plan



Typical Design Controls

- Specifying a requirement as a "critical characteristic"
- Reliability tests/design verification tests
- Design reviews
- Worst case stress analysis
- Robust/parameter design
- Environmental stress testing
- Designed experiments
- Finite element analysis
- Variation simulation and statistical tolerance analysis
- Fault Tree Analysis
- Component de-rating



FMEA as Part of ISO9001



Copyright © 2003–2007 Raytheon Company. All Rights Reserved.

Linkage to Raytheon

- DFMEA is a team effort
- DFMEA process promotes actionable input to the design phase
- Enables suppliers to add value and influence designs by highlighting functional concerns earlier in the design/development process
- The risk of some failure modes will be associated with:
 - Supplier process capabilities
 - Material or finish selection
 - Design requirements
 - Design features (or lack of)
 - Test and/or detection capabilities
- Mitigation action plan includes:
 - Supplier actions
 - Raytheon actions
 - Joint actions
- DFMEA result should be included as part of your quote activity with Raytheon



Textbooks:

- Failure Mode and Effect Analysis : FMEA from Theory to Execution; Author : D.H. Stamatis
- <u>The Basics of FMEA</u>; **Authors:** Robin E. McDermott, Raymond J. Mikulak, Michael R. Beauregard

On the Web:

- http://www.fmeainfocentre.com/
 - <u>http://www.fmeainfocentre.com/examples.htm</u>
- http://www.isixsigma.com/tt/fmea/
- <u>http://www.asq.org/learn-about-quality/process-analysis-</u> tools/overview/fmea.html





Copyright © 2003–2007 Raytheon Company. All Rights Reserved.